

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L2	210984	<i>oxide or C. stack</i> (nitride or oxynitride or (hard near3 mask\$4))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 09:26
2	BRS	L3	361338	photoresist or resist or BARC <i>FSC on fluorinated or SOG on Spin on glass</i>	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 09:26
3	BRS	L4	8196	(2 near8 3) near8 (remov\$4 or etch\$4 or strip\$4)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 09:32
4	BRS	L5	249	(2 near8 3) near8 (remov\$4 or etch\$4 or strip\$4) near8 (remov\$4 or etch\$4 or strip\$4) near4 (complete\$4 or all or total\$4 or entire\$4 or single or (one near2 step))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 09:34

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	121699 2	nitride or oxynitride or oxide or "SiO.sub.2"	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 15:44
2	BRS	L2	365906	photoresist or resist or BARC or FSG or fluorsilicate or SOG or "spin on glass"	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 15:50
3	BRS	L3	874	(1 near8 2) near8 (remov\$4 or etch\$4 or strip\$4) near4 (complete\$4 or all or total\$3 or entire or single or (one near2 step))	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:01
4	BRS	L4	113	3 same plasma	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 16:19
5	BRS	L5	132	(etch\$4) with sacrificial with (gap or hole or trench or aperture or via) with plasma	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:18

	Typ	L #	Hits	Search Text	DBs	Tim Stamp
6	BRS	L6	12049	(etch\$4 or remov\$4) with (photoresist or resist or sacrificial) with ("hard mask" or nitride)	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:20
7	BRS	L7	1475	6 with plasma	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:22
8	BRS	L8	847	7 with silicon	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:23
9	BRS	L9	51	8 with (complete\$4 or all or total\$4 or entire\$4 or single or "one step")	USPAT; US-PGP UB; EPO; JPO; DERWEN T; IBM_TD B	2003/06/27 18:24